

Data Sheet Issue: P2

Prospective Data High Power Sonic FRD Type E1000TF65F

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V _{RRM}	Repetitive peak reverse voltage, (note 1)	6500	V
V _{RSM}	Non-repetitive peak reverse voltage, (note 1)	6600	V
V _{R(d.c.)}	Maximum reverse d.c. voltage (note 1)	3600	V

	OTHER RATINGS (note 6)	MAXIMUM LIMITS	UNITS
I _{F(AV)M}	Mean forward current, T _{sink} =55°C, (note 2)	817	А
I _{F(AV)M}	Mean forward current. T _{sink} =100°C, (note 2)	429	А
I _{F(AV)M}	Mean forward current. T _{sink} =100°C, (note 3)	196	А
I _{F(AV)M}	Mean forward current. T _{sink} =100°C, (note 4)	327	А
I _{F(RMS)}	Nominal RMS forward current, T _{sink} =25°C, (note 2)	1585	А
I _{F(d.c.)}	D.C. forward current, T _{sink} =25°C, (note 5)	1445	А
I _{FSM}	Peak non-repetitive surge t_p =10ms, V_{RM} =60% V_{RRM} , (note 6)	8455	А
I _{FSM2}	Peak non-repetitive surge t_p =10ms, $V_{RM} \le 10V$, (note 6)	9300	А
l²t	$I^{2}t$ capacity for fusing t_{p} =10ms, V_{RM} =60% V_{RRM} , (note 6)	3.57×10⁵	A ² s
l²t	$I^{2}t$ capacity for fusing t _p =10ms, V _{RM} ≤10V, (note 6)	4.32×10 ⁵	A ² s
Prr	Maximum non-repetitive peak reverse recovery power, (note 8)	4.8	MW
T _{j op}	Operating temperature range	-40 to +125	°C
T _{stg}	Storage temperature range	-40 to +125	°C

Notes:-

- 1) De-rating factor of 0.13% per °C is applicable for T_j below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Anode side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Cathode side cooled, single phase; 50Hz, 180° half-sinewave.
- 5) Double side cooled.
- 6) Half-sinewave, $125^{\circ}CT_{j}$ initial.
- 7) Current (I_F) ratings have been calculated using V_{T0} and r_T (see page 2)
- 8) T_j=T_{jop}, I_F=1000Å, di/dt=3000A/μs V_r=3600V and L_s=300nH. Test circuit and sample waveform are shown in diagram 1. IGBT type T0900AF65E used as switch.

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS	
V _{FM}	Maximum peak forward voltage	-	3.42	3.82	I _{FM} =1000A	V	
		-	-	5.2	I _{FM} =2000A		
V _{T01}	Threshold voltage	-	-	1.895	Current range 333A – 1000A (Note 2)	V	
r _{T1}	Slope resistance	-	-	1.925		mΩ	
	Maximum forward recovery voltage	-	-	145	di/dt = 2000A/µs, Tj=25°C	V	
		-	-	220	di/dt = 2000A/µs		
		-	-	1	Rated V _{RRM} , T _j =25°C	mA	
I _{RRM}	Peak reverse current	-	-	25	Rated V _{RRM}		
Q _{rr}	Recovered charge	-	1600	1850		μC	
Q _{ra}	Recovered charge, 50% Chord	-	720	-	$I_{\rm FM}$ =1000A, t_p =1ms, di/dt=3000A/µs, V_r =3600V, 50% Chord. IGBT type T0900AF65E used as switch	μC	
Irm	Reverse recovery current	-	1200	1400		А	
trr	Reverse recovery time, 50% Chord	-	1.2	-		μs	
Erm	Reverse recovery loss, 50% Chord	-	2.4	2.9		J	
		-	-	0.0148	Double side cooled	K/W	
R _{thJK}	Thermal resistance, junction to heatsink	-	-	0.0221	Cathode side cooled	K/W	
		-	-	0.0452	Anode side cooled	K/W	
F	Mounting force	20	-	30	(Note 3)	kN	
W _t	Weight	-	1.0	-		kg	

Notes:-

1) Unless otherwise indicated $T_j=125^{\circ}C$. 2) V_{T0} and r_T were used to calculate the current ratings illustrated on page one. 3) For clamp forces outside these limits, please consult factory.

Additional information on Ratings and Characteristics

1.0 De-rating Factor

A blocking voltage de-rating factor of 0.13% per °C is applicable to this device for T_j below 25°C.

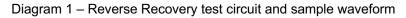
2.0 ABCD Constants

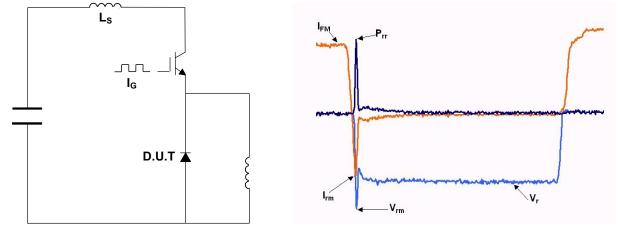
These constants (applicable only over current range of V_F characteristic in Figure 1) are the coefficients of the expression for the forward characteristic given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

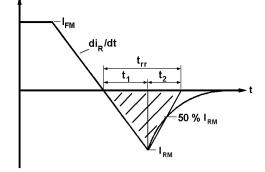
where I_F = instantaneous forward current.

3.0 Reverse recovery ratings





(i) Q_{ra} is based on 50% I_{rm} chord as shown in Figure below.



(ii) Q_{rr} is based on a 150µs integration time.

l.e.

$$Q_{rr} = \int_{0}^{150\,\mu s} i_{rr}.dt$$
$$K \ Factor = \frac{t_1}{t_2}$$



4.0 Reverse Recovery Loss

The following procedure is recommended for use where it is necessary to include reverse recovery loss.

From waveforms of recovery current obtained from a high frequency shunt (see Note 1) and reverse voltage present during recovery, an instantaneous reverse recovery loss waveform must be constructed. Let the area under this waveform be E joules per pulse. A new sink temperature can then be evaluated from:

$$T_{SINK} = T_{J(MAX)} - E \cdot \left[k + f \cdot R_{th(J-Hs)}\right]$$

Where k = 0.2314 (°C/W)/s

- E = Area under reverse loss waveform per pulse in joules (W.s.)
- f = Rated frequency in Hz at the original sink temperature.

 $R_{th(J-Hs)}$ = d.c. thermal resistance (°C/W)

The total dissipation is now given by:

$$W_{(tot)} = W_{(original)} + E \cdot f$$

NOTE 1 - Reverse Recovery Loss by Measurement

This device has a low reverse recovered charge and peak reverse recovery current. When measuring the charge, care must be taken to ensure that:

(a) AC coupled devices such as current transformers are not affected by prior passage of high amplitude forward current.

(b) A suitable, polarised, clipping circuit must be connected to the input of the measuring oscilloscope to avoid overloading the internal amplifiers by the relatively high amplitude forward current signal.

(c) Measurement of reverse recovery waveform should be carried out with an appropriate critically damped snubber, connected across diode anode to cathode. The formula used for the calculation of this snubber is shown below:

$$R^2 = 4 \cdot \frac{V_r}{C_s \cdot di/dt}$$

Where: V_r = Commutating source voltage C_S = Snubber capacitance R = Snubber resistance

5.0 Computer Modelling Parameters

5.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0}^{2} + 4 \cdot ff^{2} \cdot r_{T} \cdot W_{AV}}}{2 \cdot ff^{2} \cdot r_{T}}$$

Where V_{T0} =1.895V, r_T =1.925m Ω

ff = form factor (normally unity for fast diode applications)

$$W_{AV} = \frac{\Delta T}{R_{th}}$$
$$\Delta T = T_{j(MAX)} - T_K$$

5.2 Calculation of VF using ABCD Coefficients

The forward characteristic IF Vs VF, on page 6 is represented in two ways;

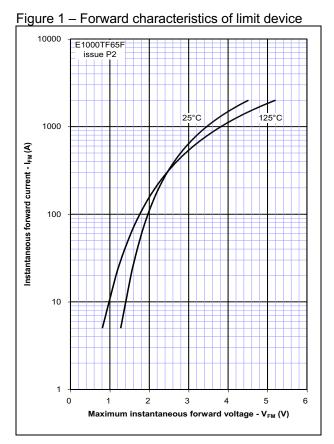
- (i) the well established V_{T0} and r_T tangent used for rating purposes and
- (ii) a set of constants A, B, C, and D forming the coefficients of the representative equation for V_F in terms of I_F given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

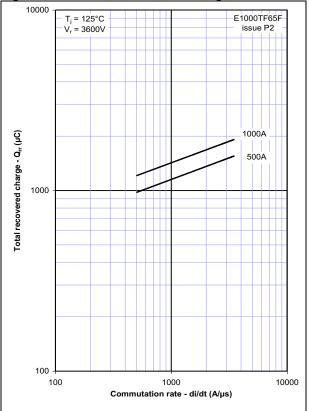
The constants, derived by curve fitting software, are given in this report for both hot and cold characteristics. The resulting values for V_F agree with the true device characteristic over a current range, which is limited to that plotted.

	25°C Coefficients	125°C Coefficients
А	0.9582830	0.43410944
В	0.12835820	0.15198510
С	5.39123×10 ⁻⁴	5.288311×10 ⁻⁴
D	0.03290293	0.05715363

<u>Curves</u>









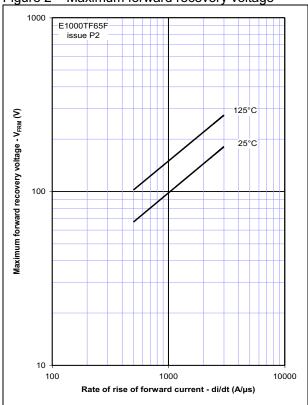
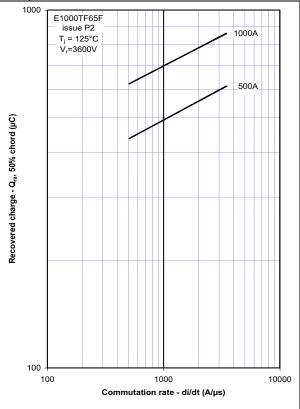
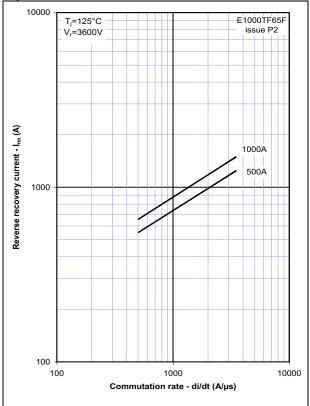


Figure 4 – Maximum recovery charge, Q_{ra} (50% chord)

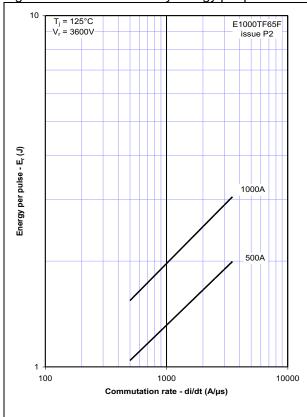


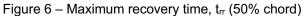


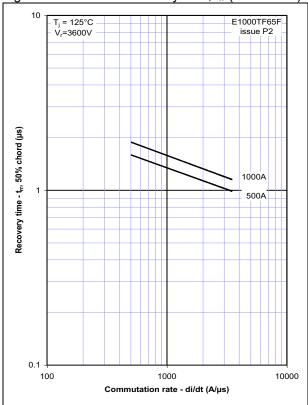


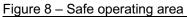


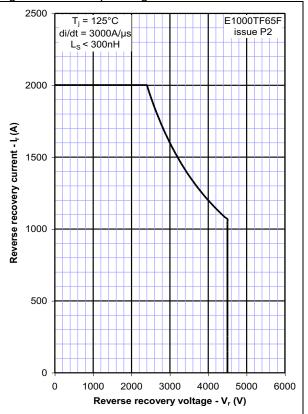












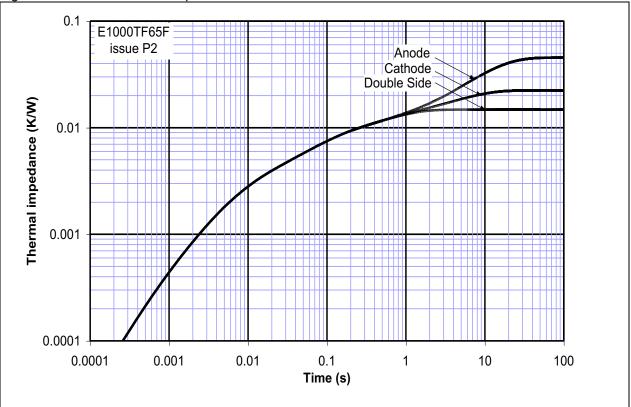
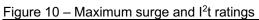
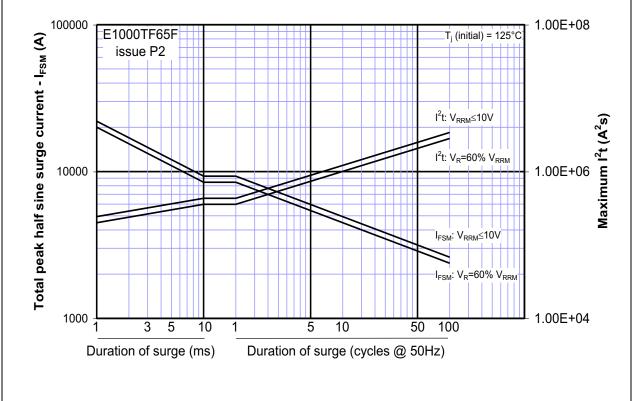


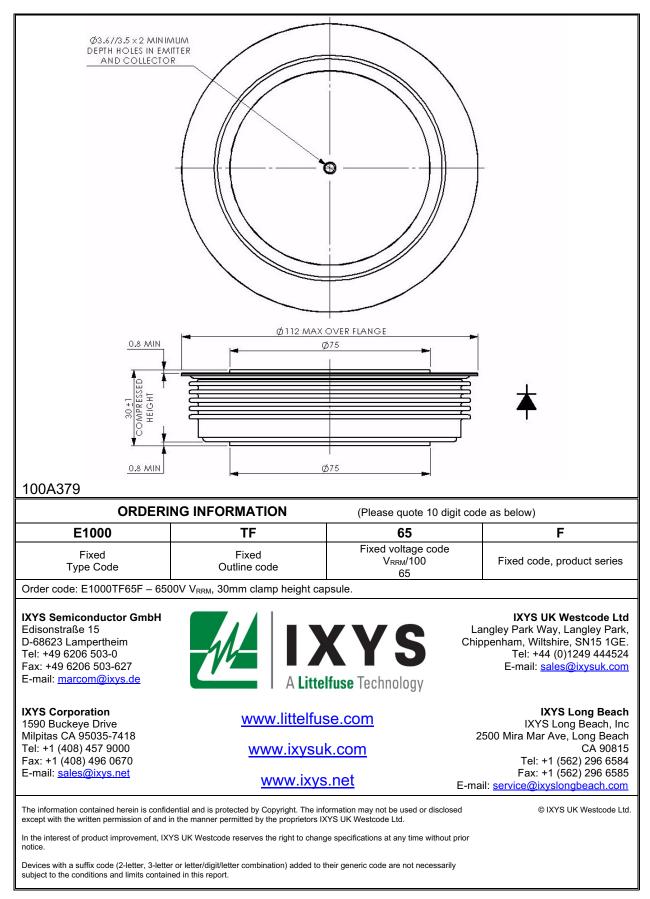
Figure 9 – Transient thermal impedance







Outline Drawing & Ordering Information





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